

MEG II実験における大強度 μ 粒子ビーム中での運用を見据えた超低物質質量RPCのレート耐性の研究 (2)

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Core-to-Core Program

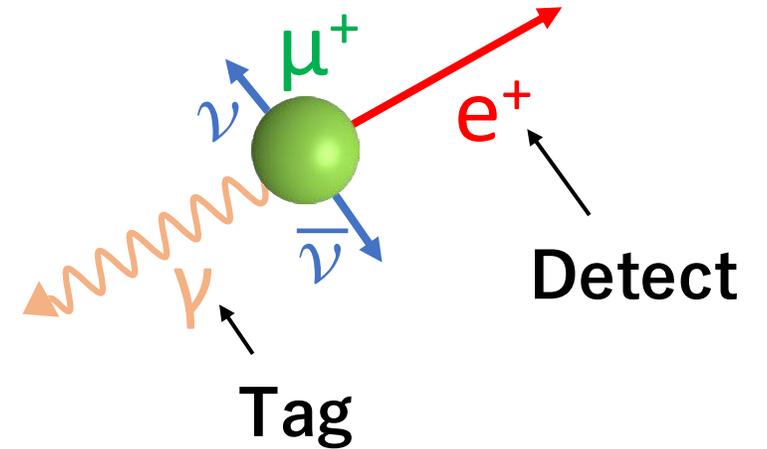


Contents

- Introduction
- Measurement with high rate μ beam
 - Setup
 - Height spectra
 - Evaluated voltage drop
- Projection to MEG II performance
- Summary and prospect

Ultra-low material RPC for MEG II

- Detectors to **tag BG- γ** from radiative muon decay

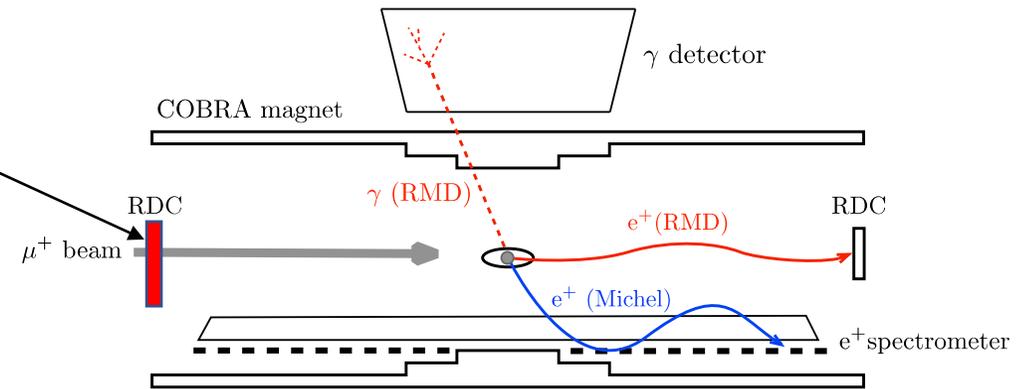


- RPC will be exposed to MEG II high-intensity μ beam
→ **Rate capability is needed**

- Beam test conducted in 2020

- Previous talk deal with

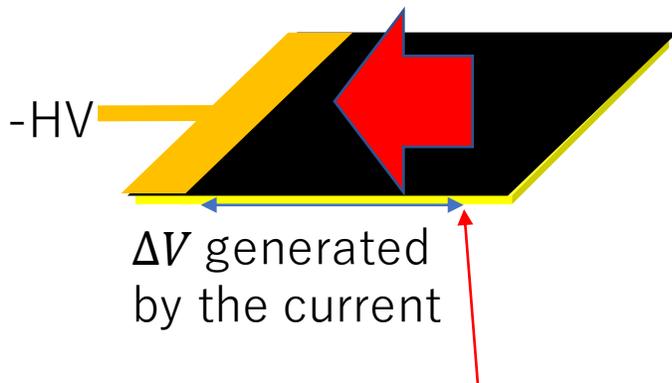
- RPC's response to low-momentum μ
(Measured without dependence on rate-capability)



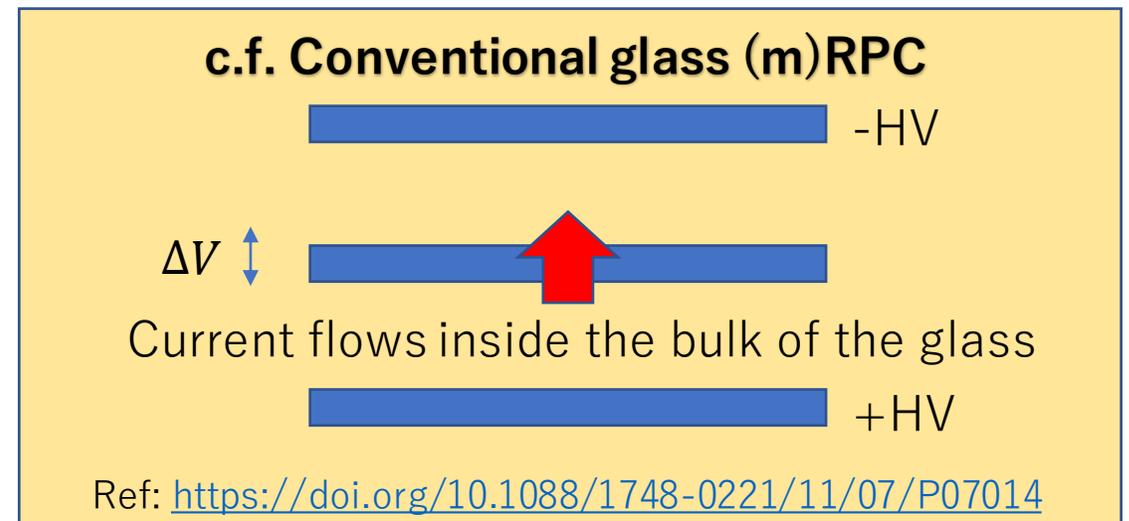
(See the slide for the previous talk for detail)

Introduction: Rate capability of RPC

- Amplified electron-ion pairs flow out on the resistive electrodes
 - Large current is generated when hit rate is high
 - The current cause voltage drop: $\Delta V = R \cdot I$
 - RPC's performance get worse with lower effective voltage
- Geometry of flowing current must be taken into account
 - Current flows on the surface of the DLC electrodes



True voltage at this point is $-HV + \Delta V$

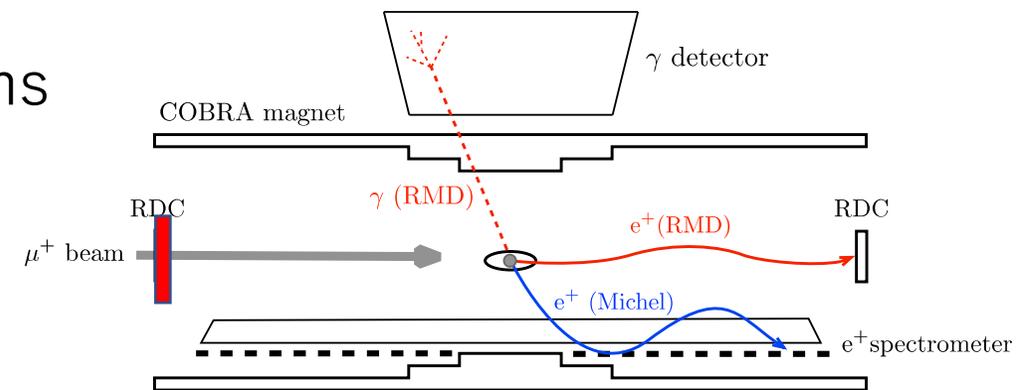
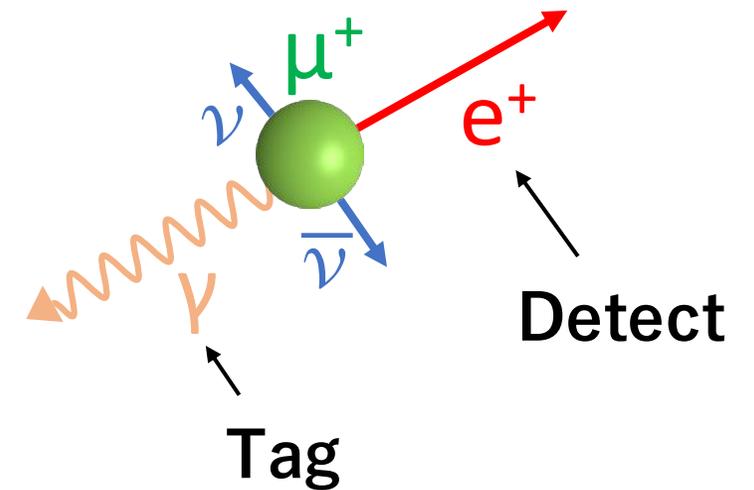


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- Measurement with high rate μ beam
 - Purpose
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Purpose of test with high-rate beam

- Reminder of RPC's use in MEG II
 - Detection of MIP in high-rate muon beam
- Purpose of test with high-rate beam
 1. RPC's performance in high-rate environment
→ To be measured for our RPC for the first time
 2. Check whether ΔV effect reasonably explains the RPC's performance in high-rate beam
- MEG II beam line is used
 - Beam is not collimated, unlike the previous talk



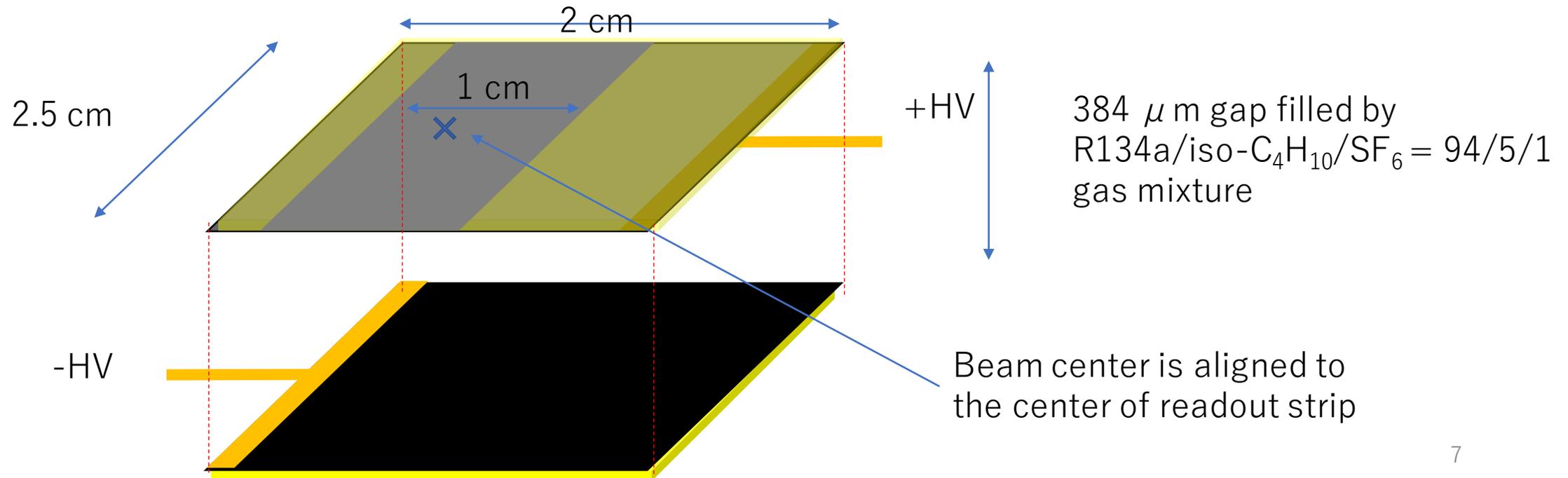
Setup: Detail of RPC structure

- The same prototype as that mentioned in the previous talk

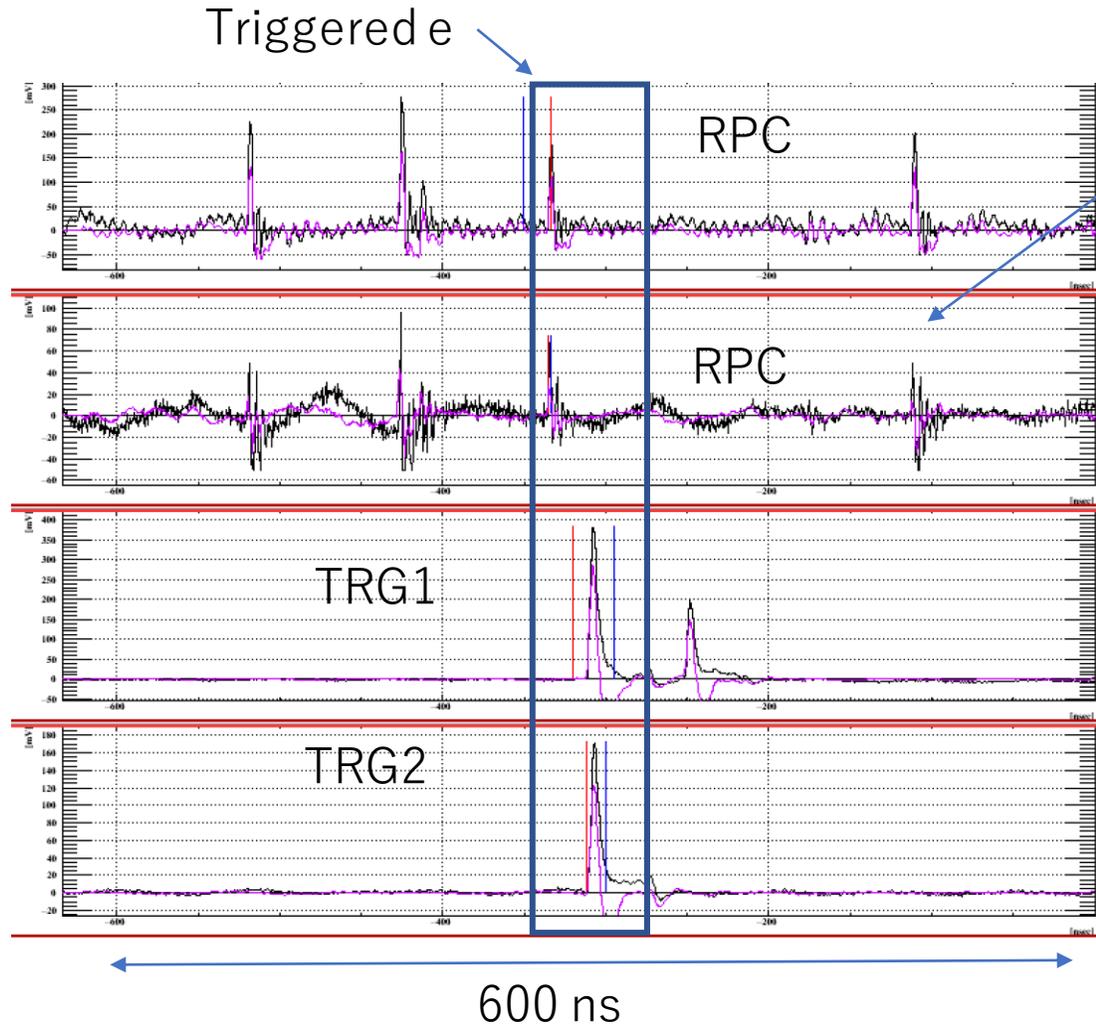
DLC resistivity:
~30 M Ω /sq for +HV side
~10 M Ω /sq for -HV side



The effective resistivity is 20 – 30 M Ω
between the sensitive region
and the HV supply electrodes



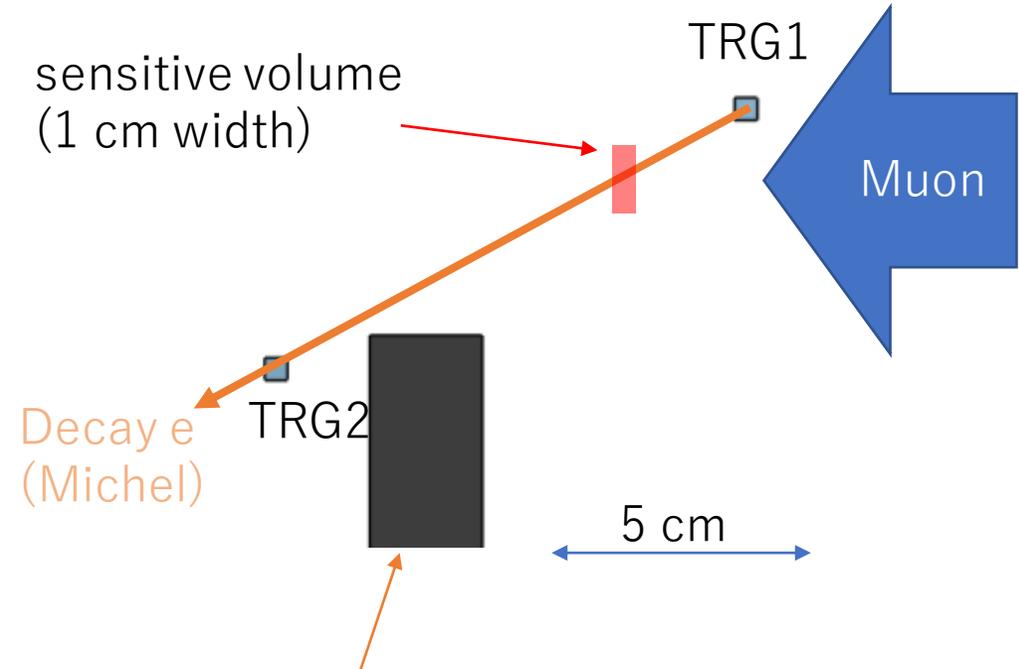
Measurement set up with high-rate beam



(~30 ns timing difference b/w RPC and TRG is from cabling)

Most likely to be mu

- In this setup
- RPC is exposed to beam
 - Michel positron is triggered



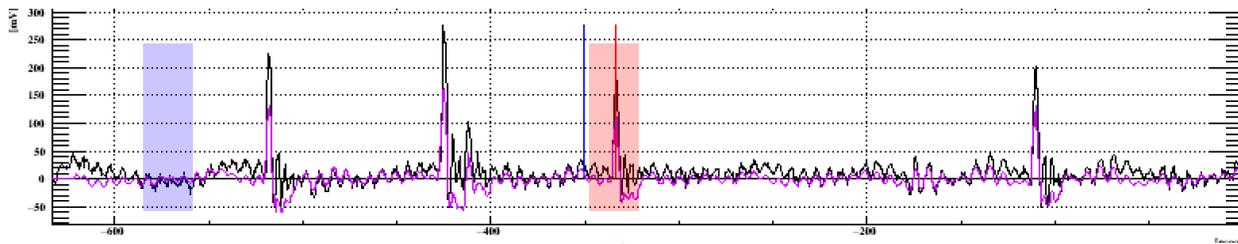
Pulse height spectra with high-rate beam

- Beam profile

- Total beam rate: $2 \times 10^7 \mu/s$
- Beam size: $\sigma_x = 13 \text{ mm}$, $\sigma_y = 23 \text{ mm}$

- Operating voltage: 2.75 kV

- Current: Read as $6.5 \mu A$



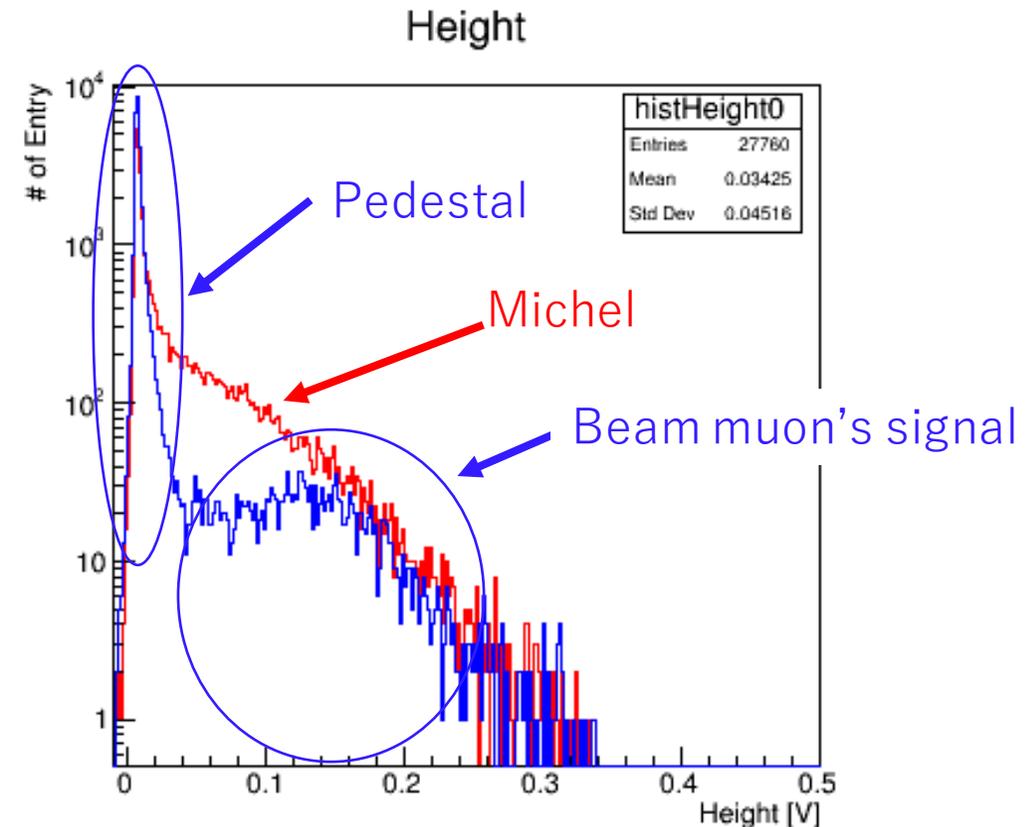
On-timing (Michel expected)

Off-timing; Mostly pedestal.

Beam muon also enter at some probability

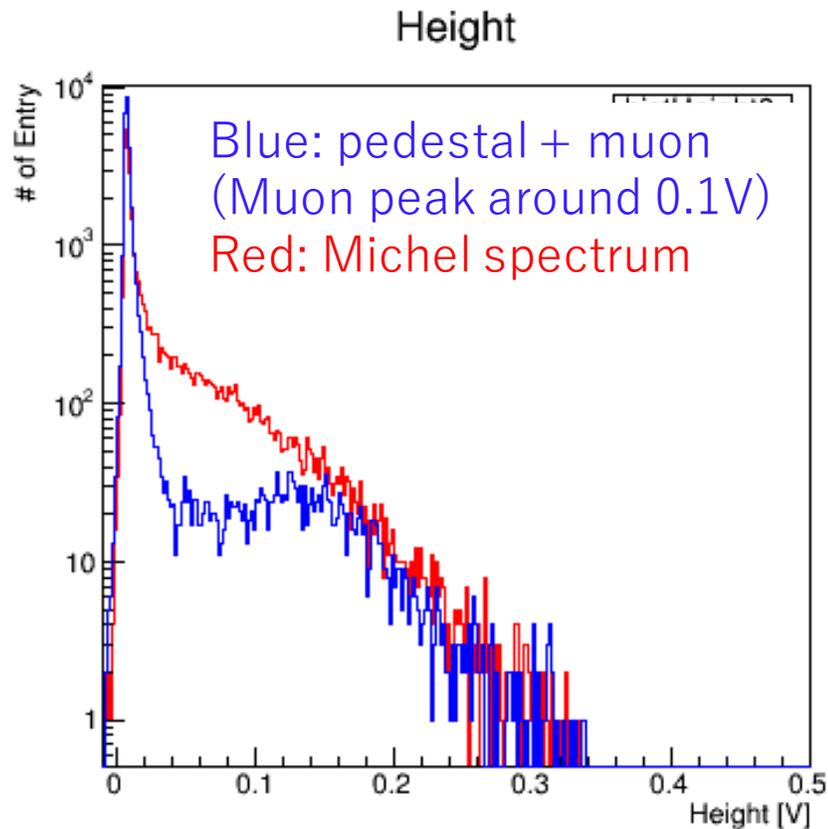
Blue: Pulse height spectra for fixed off-timing analysis window: pedestal + Beam muon

Red: Pulse height spectra for triggered timing analysis window; Mostly Michel, w/ accidental

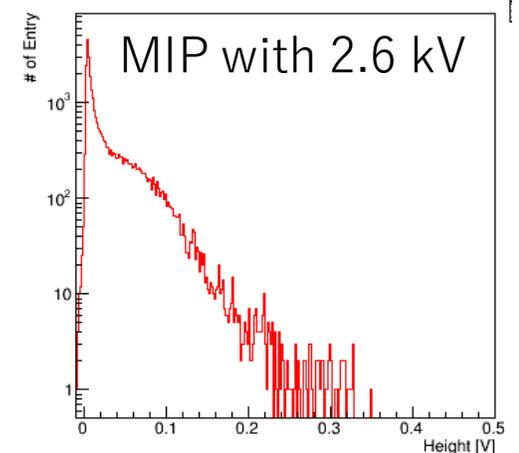
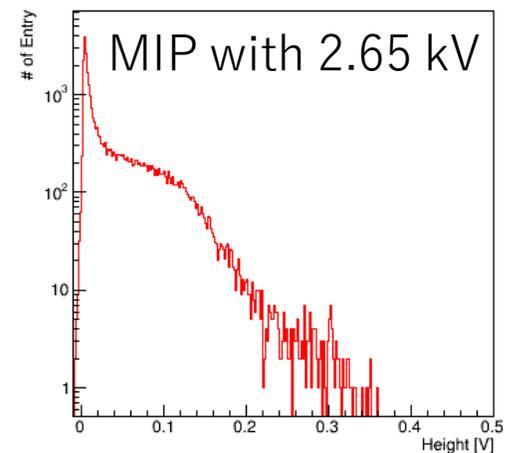
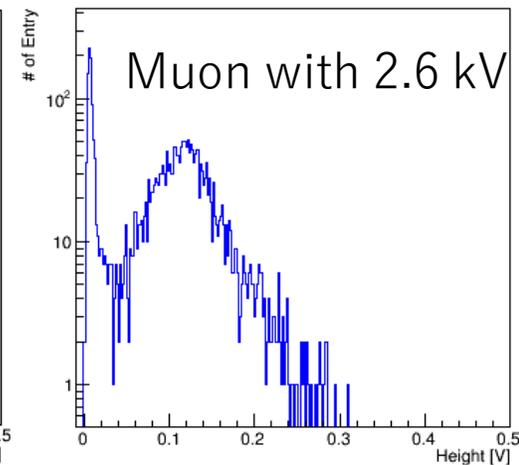
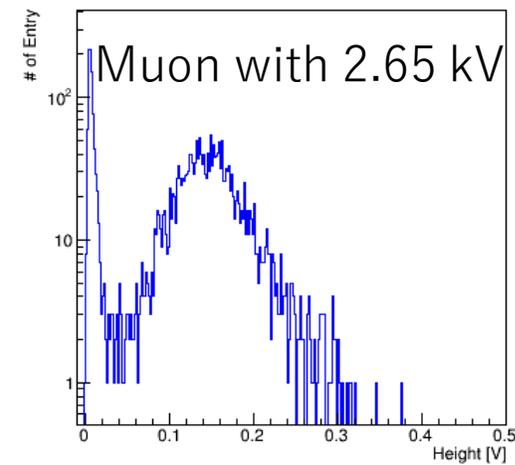


Comparison with measurements at low-rate

- Voltage drop effect appears
 - Distribution looks as that of 2.6 – 2.65 kV
 - Operated @2.75 kV \rightarrow \sim 100 V drop



Pulse height taken with sufficiently low-rate



Interpretation of the results

- Voltage drop is observed at high rate
 - Estimated effective voltage: 2600 – 2650 V
 - Nominal applied voltage: 2750 V
- Voltage drop is estimated to be 100 – 150V:
This can be understood with $\Delta V = R \cdot I$
 - $R = 20 - 30 \text{ M}\Omega$:
Determined by
 - DLC's surface resistivity
 - Geometry of the flowing current
 - $I = 6.5 \text{ }\mu\text{A}$: Current generated from avalanche charge

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- Introduction
- Measurement with high rate μ beam
- Projection to MEG II performance
 - Method on projection
 - Avalanche charge evaluation for low momentum μ
 - Expected performance
- Summary and prospect

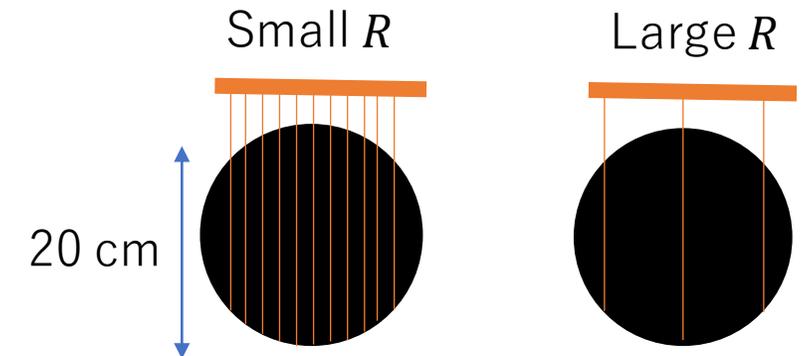
Strategy of rate capability study

- The test condition with high-rate beam is different from MEG II

- **Prototype detector** with a size smaller than required one
- **Beam profile** is different

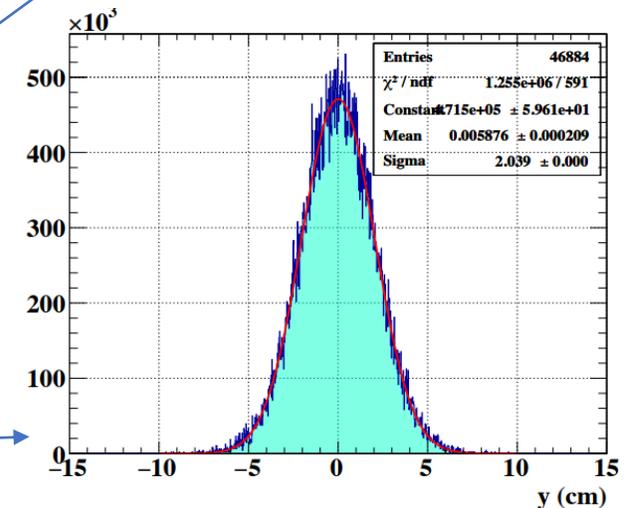
- $\Delta V = R \cdot I$ evaluation for MEG II is needed

- I is determined by
 1. Average charge in avalanche (Magnitude of current)
 2. The beam profile (Distribution of current source)
- R is determined by
 1. Surface resistivity of DLC
→ $> \sim 10 \text{ M}\Omega/\text{sq}$ is needed to suppress discharge
 2. HV supply arrangement
→ Candidate: 2 cm pitch strip-shaped HV supply



- I evaluation is the topic of the remaining talk

- Beam profile with $\sigma = 20 \text{ mm}$
- Average charge evaluation

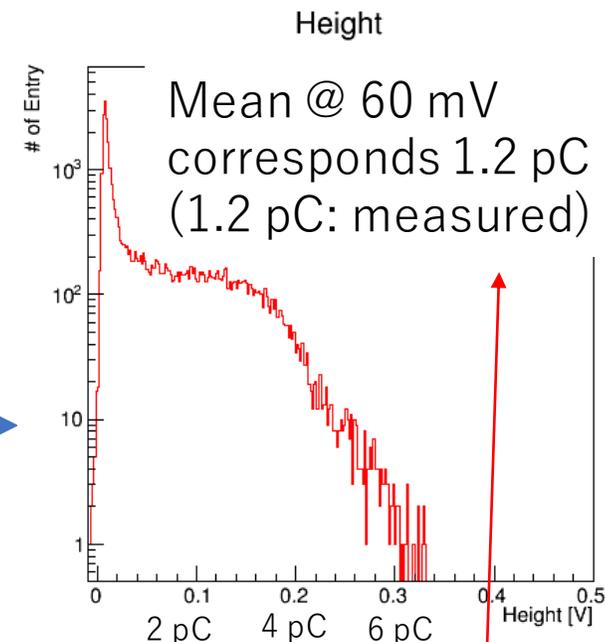


Avalanche charge evaluation

- Evaluation of avalanche charge for μ :
Signal height \propto *avalanche charge* relation
 - Proportional constant: measured with ^{90}Sr -beta

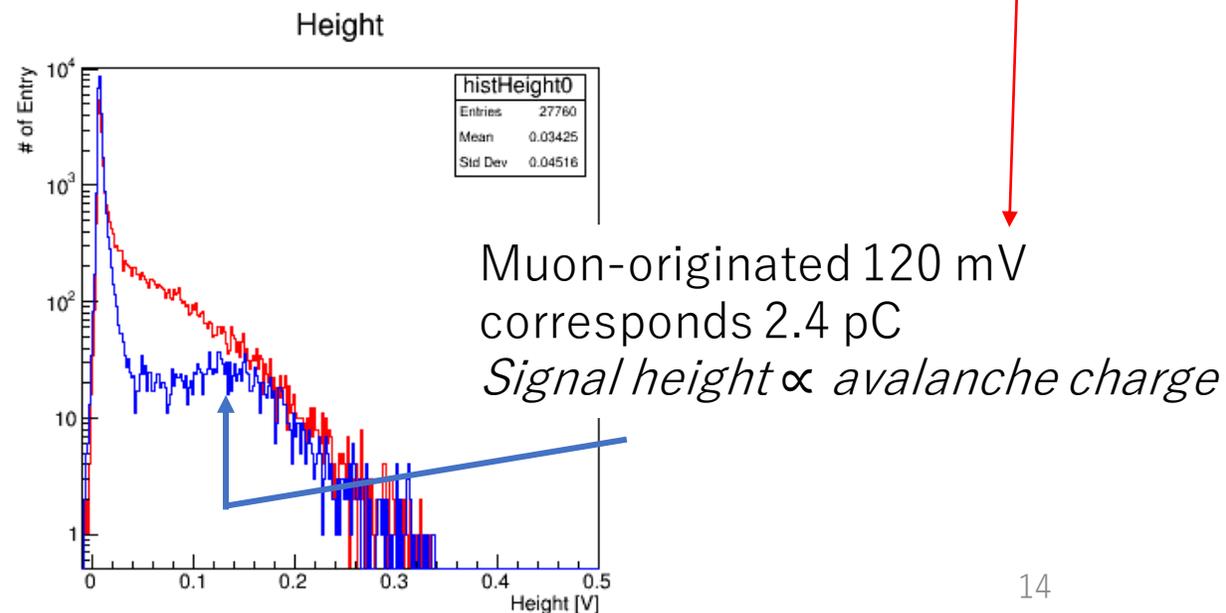
This measurement with ^{90}Sr -beta agrees with other studies

- [https://doi.org/10.1016/S0168-9002\(01\)01914-3](https://doi.org/10.1016/S0168-9002(01)01914-3)
- <https://doi.org/10.1088/1748-0221/11/07/P07014>



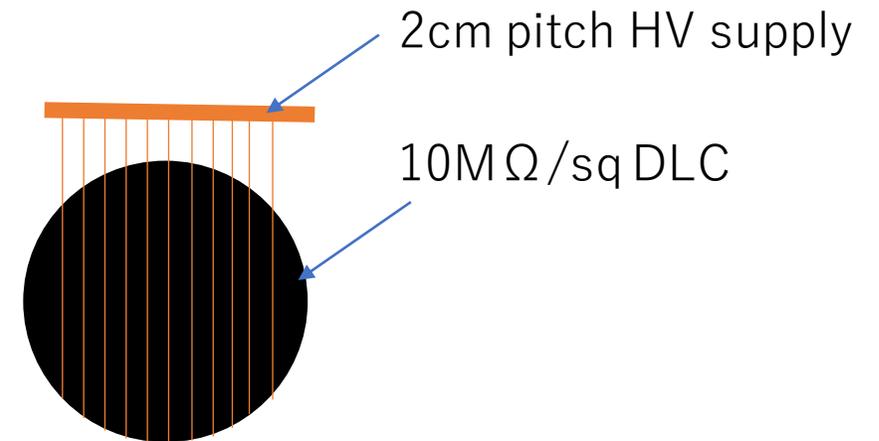
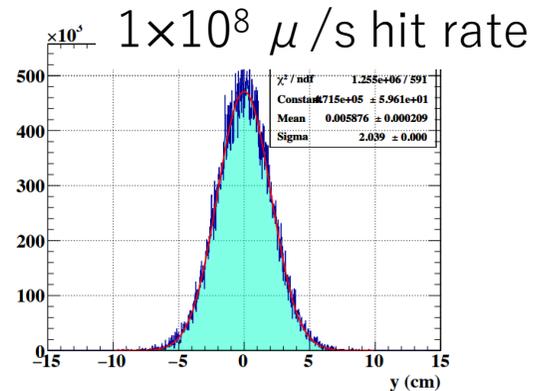
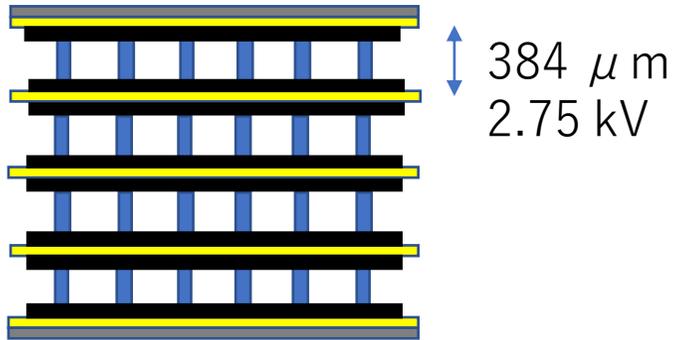
- In high-rate μ beam,
average avalanche charge: 2.4 pC
 - Consistent with generated current:
 $2.7 \text{ MHz} \times 2.4 \text{ pC} \sim 6.5 \mu\text{A}$

Estimated hit rate



Expected performance in MEG II

● Assumptions on detector configuration



● Result

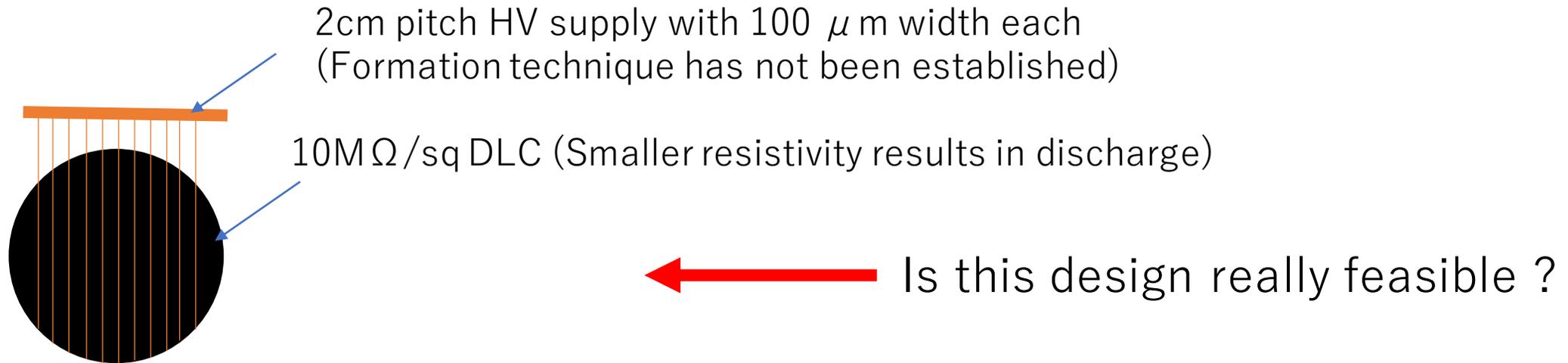
- $\Delta V \sim 100 \text{ V}$
→ Effective voltage is 2.65 kV
- Single layer efficiency is measured to be $> 40\%$ with 2.65 kV
→ **90 % efficiency is achievable with 4-layers**
($1 - \epsilon_n = (1 - \epsilon_1)^n$: ϵ_n is n-layer efficiency)

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Summary and Prospect

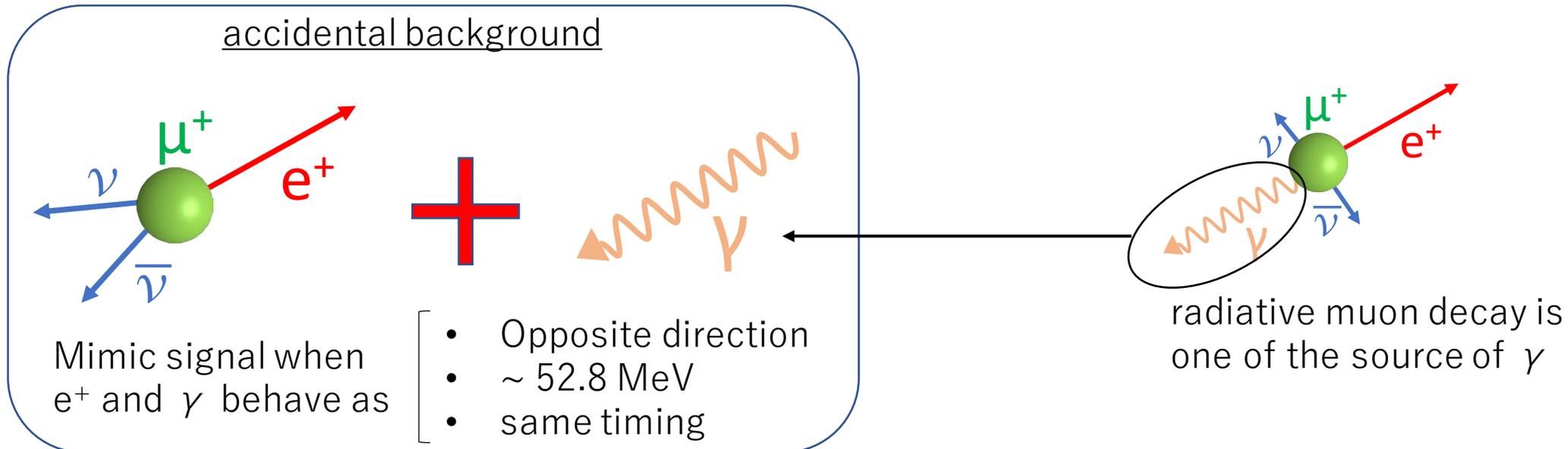
- Rate capability of RPC in MEG II experiment is studied
 - **RPC is operational even in MEG II beam**
 - But with some uncertain assumptions
- Studies are needed on the uncertain assumptions



Backup

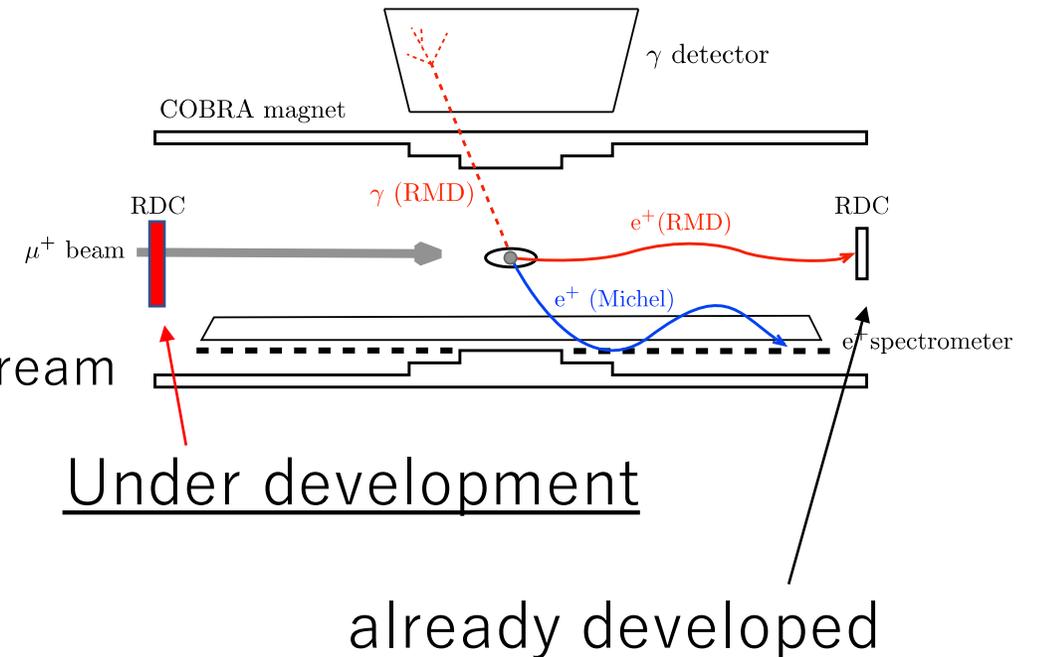
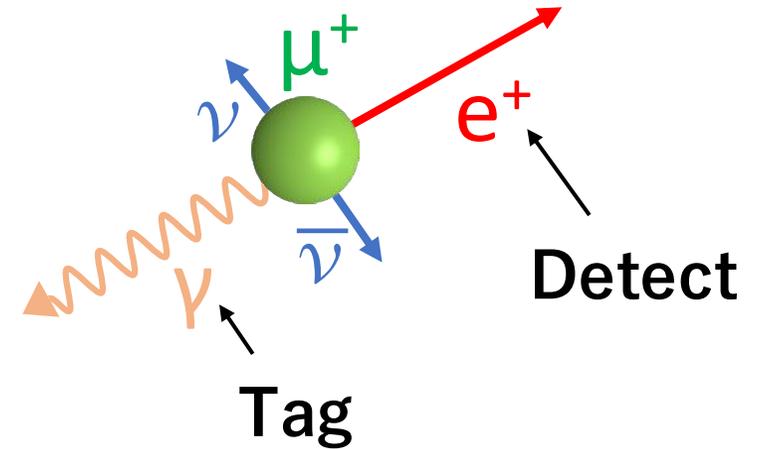
MEG II signal and background

- MEG II will search for $\mu \rightarrow e \gamma$ decay
 - Identified by energy, timing and direction of e and γ
- Dominant source of background is accidental coincidence of BG- e and BG- γ mimicking the signal
 - One of the dominant source of BG- γ is radiative muon decay



Background identification detector

- Detectors to **tag BG- γ** from radiative muon decay
 - **Detect low energy positron** (1-5MeV) accompanying BG γ (~ 52.8 MeV)
- Planned to be installed to 2 positions
 - Upstream and downstream of the target
 - MEG II sensitivity
 - 2—9% (study ongoing) improvement with upstream (Only t measurement)
 - 10% improvement with downstream (E and t measurement)
 - **Upstream one is under development**
→ Today's talk



Requirements to the upstream detector

1. $< 0.1\%$ X_0 material budget (beam must pass through the detector)
2. 90% efficiency for 1-5 MeV positron
3. 1 ns timing resolution
(RMD identification with the timing difference b/w positron & γ)
4. $10^8\ \mu/s$ capable high rate performance and radiation hardness
($10^8\ \mu/s$ with 21 MeV/c, >60 weeks run)
5. 20 cm (diameter) detector size (45% acceptance...total 90% incl. DS)

→ Candidate: Ultra low-material RPC detector using Diamond Like Carbon (DLC)

RPC based on DLC technology

- RPC: Gaseous detector with high resistive electrodes placed face to face
 - Gas: R134a (Freon) based
 - Gap thickness: $200\ \mu\text{m} - 2\ \text{mm}$

Performance of conventional RPC

- time resolution $< \text{ns}$
- material: $1\% X_0 \rightarrow$ must be improved
- Efficiency $\sim 90\% \rightarrow$ still requires study
- rate $\sim \text{kHz}/\text{cm}^2 \rightarrow$ must be improved

- Diamond Like Carbon(DLC) is used for resistive electrodes

- DLC: high resistive material w/ mixed structure of sp^2 bond and sp^3 bond

- Advantages of DLC

1. low material \rightarrow Sputter DLC on $50\ \mu\text{m}$ Kapton

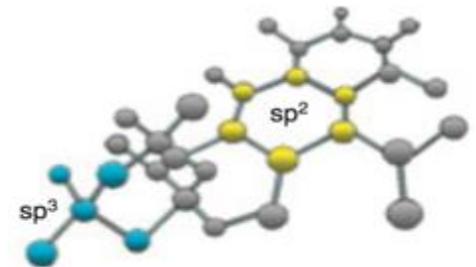
2. Adjustable resistivity

\rightarrow Resistivity must be optimized for high rate environment
(Resistivity must be low to achieve high rate capability)

3. Multiple layers with lower voltage than conventional ones (next page)

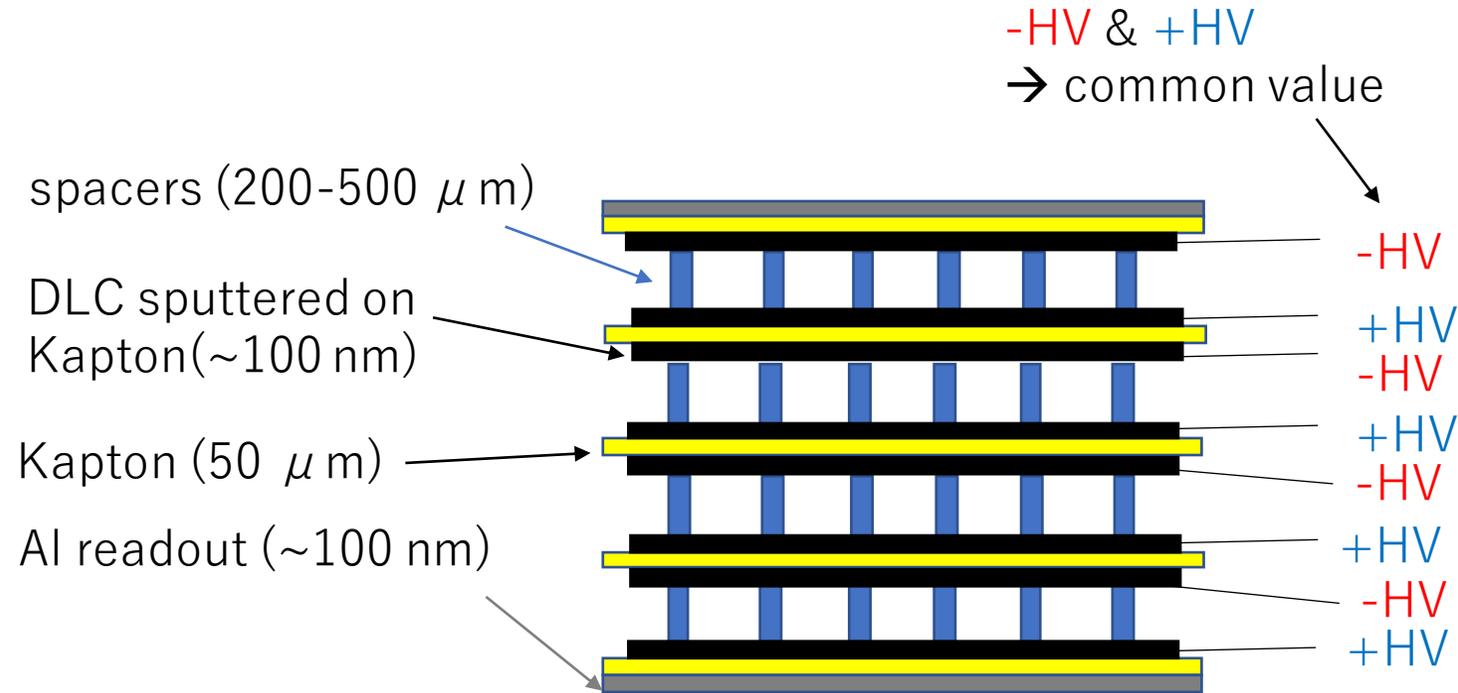
- Development initiated by a group of Kobe Univ

DLC: chemical structure



Proposed design of RPC for MEG II

- Readout: Al
 - aluminized Kapton will be used on the top & bottom



- High efficiency can be achieved by multilayer design
 - n-layer efficiency: $\epsilon_n = 1 - (1 - \epsilon_1)^n$
 - From requirement on material budget, 4 layers at maximum

Material budget

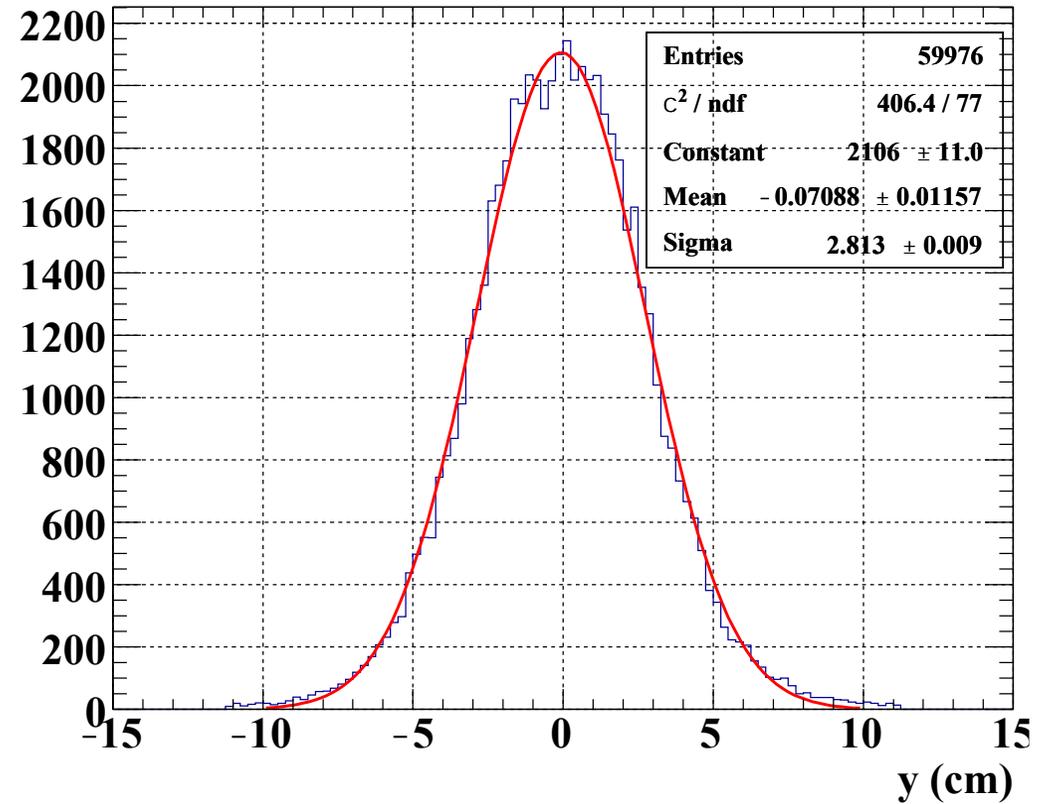
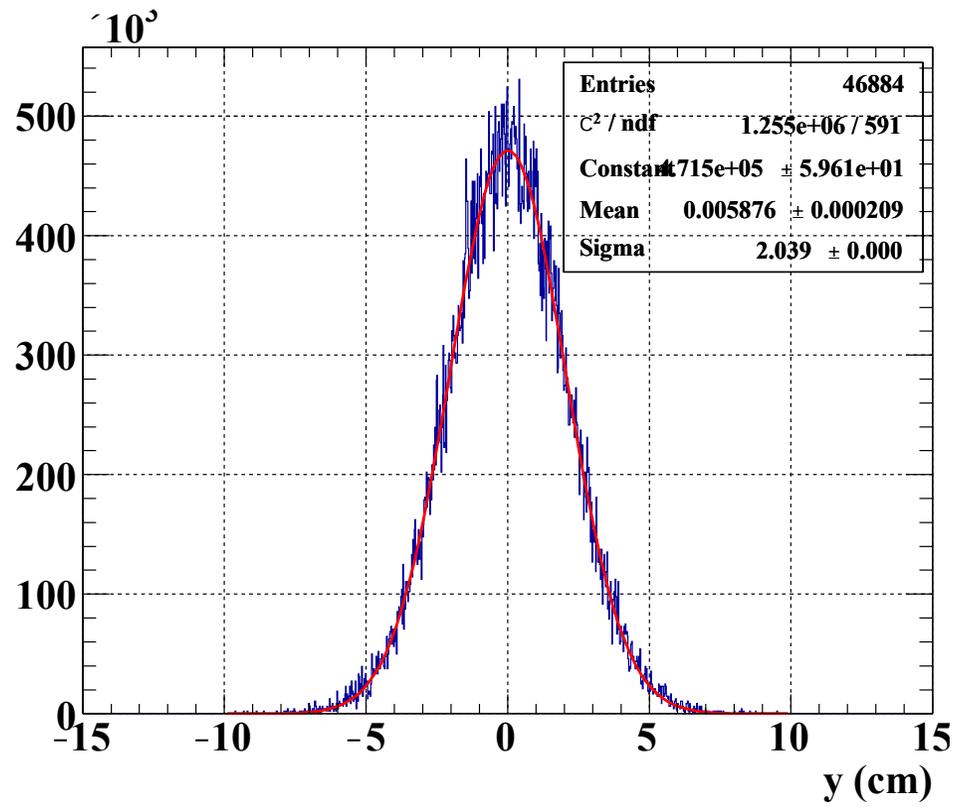
- Kapton 50 μm → 0.018 % X_0
- Al 100 nm × 2枚 → 0.0023 % X_0

→ < 0.1 % X_0 is achievable

ビーム μ とか

● 粒子の拡がり

- ✓ ビームの拡がりは $\sigma = 2$ cm
- ✓ 輻射崩壊陽電子は 2.8 cm



Result: Timing resolution for single layer

- Single layer timing resolution is measured changing the gap thickness

- (Normally, 4-layer resolution is better)

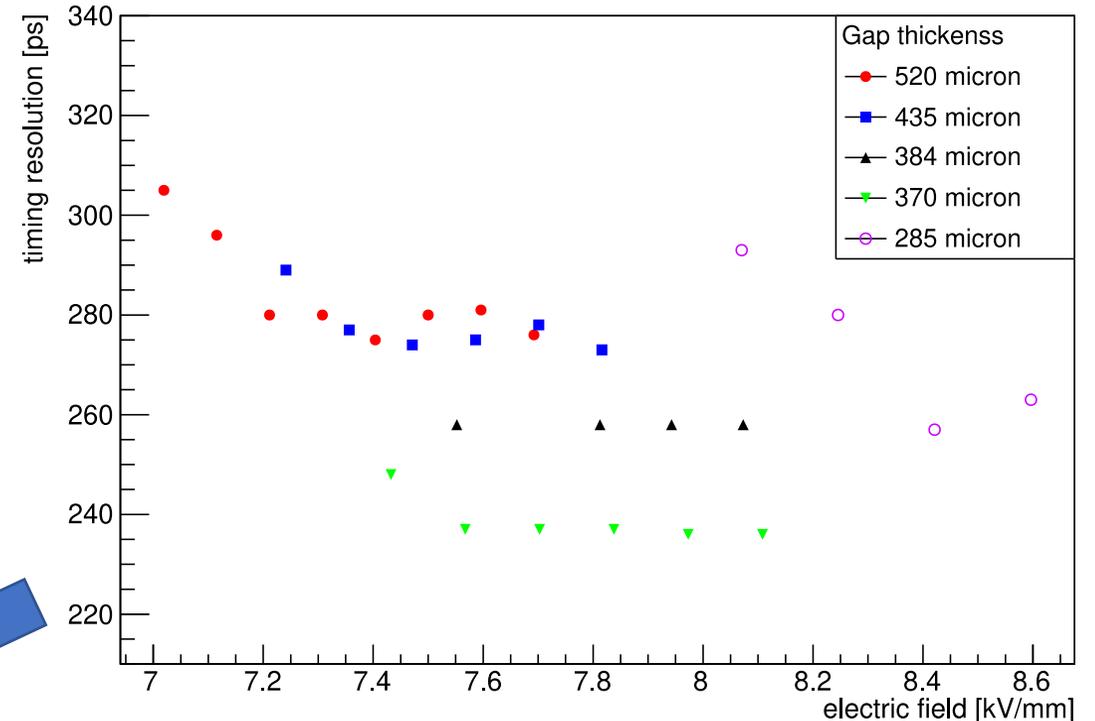
- Timing resolution

- Determined from the timing difference b/w RPC and reference counter
- RPC timing: 50% constant fraction

Timing resolution is good enough at least up to 520 μm
($< 1\text{ns}$ required)



timing resolution vs electric field



At least, gap thickness can be b/w 370 μm and 520 μm

Result: Detection efficiency for single layer

- Single layer efficiency is measured changing the gap thickness
 - 40% single layer efficiency is required to achieve 90% w/ 4-layer
 - $\epsilon_n = 1 - (1 - \epsilon_1)^n$
 - For each thickness, measured changing the operating voltage

- Efficiency

- Determined from the fraction of RPC hits in the triggered events
- RPC threshold = 10 mV

**sufficient efficiency for
 $\geq 370 \mu\text{m}$ thickness**

